

02-10-2000

EET

U.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office



101263365

Tab settings

To the Honorable Commissioner of Patents and Trademarks, the attached original documents or copy thereof.

1. Name of conveying party(ies):

Bill J. Pope Richard H. Dixon
Michael A. Vail Kenneth M. Jensen
Jeffery K. Taylor Clayton F. Gardinier
Dean C. Blackburn Louis M. Pope

1/31/06

Additional names(s) of conveying party(ies)

☐ Yes ☒ No

2. Name and address of receiving party(ies):

Name: Diamicron, Inc.Address: 1186 South 1680 West

JCT10 U.S. PTO
09/494237
01/30/00

3. Nature of conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other

Execution Date: 1/26/2000City: Orem State/Prov.: UTCountry: USA ZIP: 84-58

Additional name(s) & address(es)

☐ Yes ☒ No

4. Application number(s) or registration numbers(s):

If this document is being filed together with a new application, the execution date of the application is: 1/26/2000

Patent Application No. Filing date

B. Patent No.(s)

69494237

Additional numbers

☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Daniel McCarthyRegistration No. 36,600Address: McCarthy & Sadler, LC39 Exchange Place, #100City: Salt Lake City State/Prov.: UTCountry: USA ZIP: 84111

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41):.....\$ 40.00☒ Enclosed - Any excess or insufficiency should be credited or debited to deposit account☐ Authorized to be charged to deposit account

8. Deposit account number:

40.00 DP

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Daniel McCarthy

Name of Person Signing

Signature

Date

Total number of pages including cover sheet, attachments, and

3/08/2001 WILLIAMS
00000034
101263365

PATENT

REEL: 010532 FRAME: 0850

ASSIGNMENT

Inventors:	Bill J. Pope	^{Jeffery} Jeffrey K. Taylor	Richard H. Dixon
	Clayton F. Gardinier	Louis M. Pope	Dean C. Blackburn
	Michael A. Vail	Kenneth M. Jensen	

Invention: Prosthetic Hip Joint Having At Least One Sintered Polycrystalline Diamond Compact Articulation Surface and Substrate Surface Topographical Features in Said Polycrystalline Diamond Compact

Docket: 6064 P

WHEREAS, the Inventors have made an invention or discovery referred to as the "Invention" which is described and claimed in the attached application for Letters Patent of the United States; and

WHEREAS, Diamicron, Inc., Utah corporation ("Diamicron"), is desirous of acquiring all of the Inventors' rights, title and interest in said invention or discovery:

NOW, THEREFORE, in return for good and valuable consideration, receipt of which is hereby acknowledged, each of the Inventors, by these presents, does hereby sell, assign, and transfer unto Diamicron all rights, title and interest in and to the following: (1) said Invention as described in said patent application, (2) said patent application, (3) any letters Patent issuing from said patent application, and (4) all intellectual property (including patent rights, trade secrets and copyrights) in or to said Invention. Said assignment is without any geographic limitation and shall include the United States of America and all foreign countries. All rights, title and interest in said Invention, said patent application, any Letters Patent issuing from said patent application, and said intellectual property are to be held and enjoyed by Diamicron for its own use and behalf, and for that of its legal representatives and assigns, as fully and entirely as the same would have been held by the Inventors had this assignment and sale not been made. Diamicron shall be free to assign, license or otherwise exploit said Invention, said patent application, any Letters Patent issuing from said patent application, and said intellectual property.

AND each of the Inventors does further agree to sign all papers, make all rightful oaths and do all requisite acts for the filing of any disclaimer or for the filing and assignment of any other patent application (including divisional, continuing, continuation-in-part, reissue and foreign applications) based on the present patent application or said Invention. Any such other patent application is deemed to be part of the above assignment.

AND each of the Inventors does further agree to communicate to Diamicron, its successors, assigns or other legal representatives, such facts relating to said Invention as may be known to him, and to testify as to such facts in any prosecution, interference or litigation.

Executed by the undersigned on the date indicated.

Inventor's Signature:

Inventor's Full Name:

Date:

Inventor's Signature:

Inventor's Full Name:

Date:

Inventor's Signature:

Inventor's Full Name:

Date:

Inventor's Signature:

Inventor's Full Name:

Date:

Inventor's Signature:

Inventor's Full Name:

Date:

Inventor's Signature:

Inventor's Full Name:

Date:

Inventor's Signature:

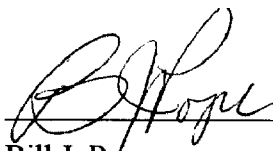
Inventor's Full Name:

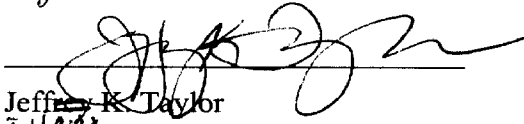
Date:


Inventor's Signature:

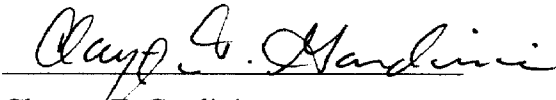
Inventor's Full Name:

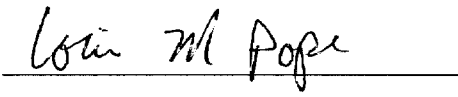
Date:



Bill J. Pope
Jan 24, 2000



Jeffrey K. Taylor
Jeffery
Jan. 24, 2000

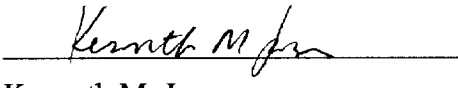

Richard H. Dixon
1/24/2000


Clayton F. Gardinier
1-24-00


Louis M. Pope
01/24/00


Dean C. Blackburn
Jan 27, 2000


Michael A. Vail
Jan 24, 2000


Kenneth M. Jensen
Jan 28, 2000